

IGBT MODULE

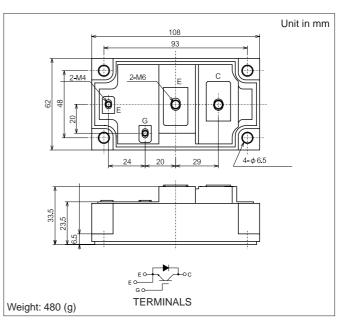
BN400GS12AW

Silicon N-channel IGBT

OUTLINE DRAWING

FEATURES

- * High speed and low saturation voltage.
- * low noise due to built-in free-wheeling diode - ultra soft fast recovery diode(USFD).
- * Isolated head sink (terminal to base).



ABSOLUTE MAXIMUM RATINGS (Tc=25°C)

ABSULUTE MAXIMU		3 (TC=25 ⁻ C)				
Item	Symbol	Unit MBN400GS12AW				
Collector Emitter Voltage		VCES	V	1,200		
Gate Emitter Voltage		V _{GES}	V	±20		
Collector Current	DC	lc	А	400		
	1ms	I _{Cp}	A	800		
Forward Current	DC	lF	А	400 (1)		
	1ms	IFM	A	800		
Collector Power Dissipation		Pc	W	2,000		
Junction Temperature		Tj	°C	-40 ~ +150		
Storage Temperature		T _{stg}	°C	-40 ~ +125		
Isolation Voltage		VISO	V _{RMS}	2,500(AC 1 minute)		
Screw Torque Te	rminals	-	N.m	1.37(14)/2.94(30) (2)		
Mo	ounting	-	(kgf.cm)	2.94(30) (3)		

Notes:(1)RMS Current of Diode 120Arms max. (2)Recommended Value 1.18/2.45N.m(12/25kgf.cm)

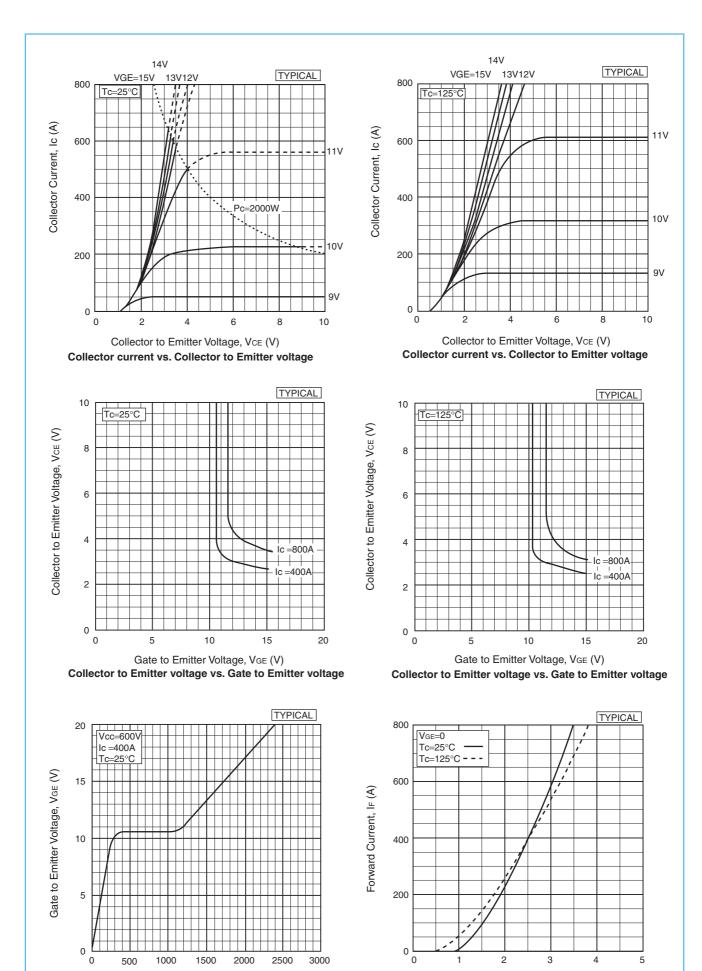
(3)Recommended Value 2.45N.m(25kgf.cm)

CHARACTERISTICS (Tc=25°C)

	100 (10 20 0)						
Item		Symbol	Unit	Min.	Тур.	Max.	Test Conditions
Collector Emitter Cut-Off Current		I CES	mA	-	-	1.0	V _{CE} =1,200V,V _{GE} =0V
Gate Emitter Leakage Current		IGES	nA	-	-	±500	V _{GE} =±20V,V _{CE} =0V
Collector Emitter Saturation Voltage		VCE(sat)	V	-	2.7	3.4	Ic=400A,VGE=15V
Gate Emitter Threshold Voltage		V _{GE} (TO)	V	-	-	10	V _{CE} =5V, I _C =400mA
Input Capacitance		Cies	рF	-	37,000	-	V _{CE} =10V,V _{GE} =0V,f=1MHz
Switching Times	Rise Time	tr		-	0.25	0.5	Vcc=600V
	Turn On Time	ton	μS	-	0.4	0.7	R∟=1.5Ω
	Fall Time	t _f		-	0.25	0.35	$R_{G}=2.7\Omega \tag{4}$
	Turn Off Time	t _{off}		-	0.75	1.1	V _{GE} =±15V
Peak Forward Voltage Drop		Vfm	V	-	2.5	3.5	IF=400A,VGE=0V
Reverse Recovery Time		trr	μS	-	-	0.4	I _F =400A,V _{GE} =-10V, di/dt=400A/µs
Thermal Impedance	IGBT	Rth(j-c)	°C/W	-	-	0.06	Junction to case
	FWD	Rth(j-c)		-	-	0.14	

Notes:(4) R_G value is the test condition's value for decision of the switching times, not recommended value. Determine the suitable R_G value after the measurement of switching waveforms (overshoot voltage,etc.)with appliance mounted.

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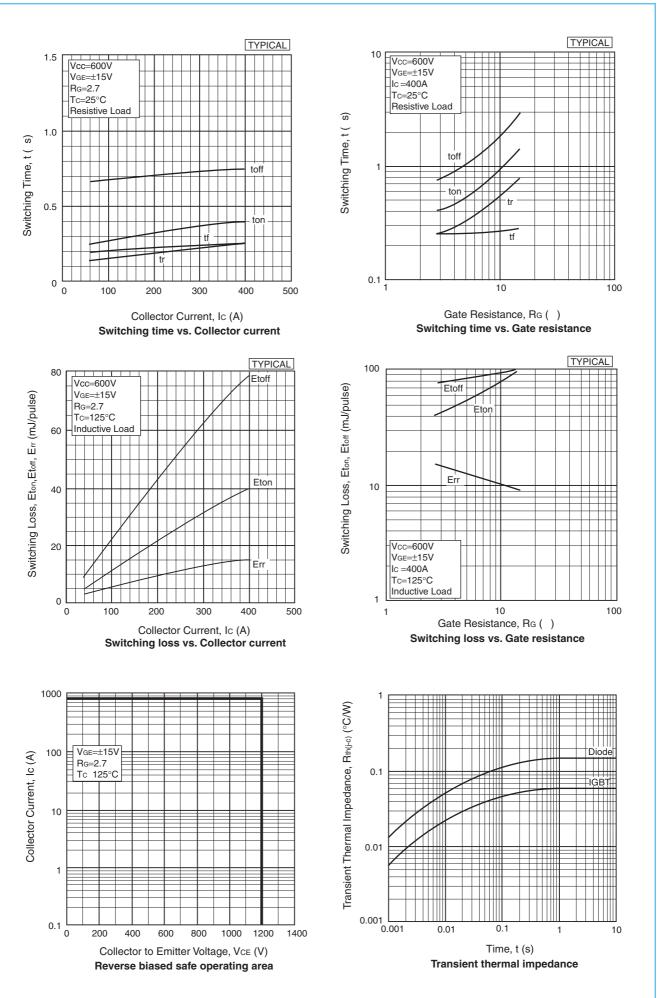


Forward Voltage, VF (V) Forward voltage of free-wheeling diode

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Gate Charge, QG (nc)

Gate charge characteristics



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HITACHI POWER SEMICONDUCTORS

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